THIN FILM SURFACE MOUNT

Bandpass Filter

ABF-8R075G+

50Ω 7750 to 8400 MHz

KEY FEATURES

- Low Passband Insertion Loss of 1.6 dB Typ.
- High Rejection of 56 dB Typ.
- Good Return Loss of 14 dB Typ.
- Small Size, 5.59 x 8.13 x 2.03 mm

APPLICATIONS

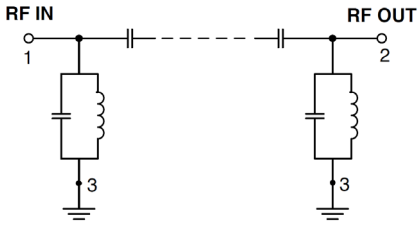
- Phased Array SATCOM Antenna
- Aerospace and Defense Signal Conditioning
- Test and Measurement Equipment

Generic photo used for illustration purposes only

PRODUCT OVERVIEW

Mini-Circuits' Surface Mount Thin-Film filters offer low insertion loss and high rejection realized via Thin-Film on Alumina substrate, using a sputtering process that can guarantee an enhanced Q and repeatable performance. Low pass, high pass, and bandpass surface mount thin-film designs can be realized with this technology up to 40GHz in a small form factor helping customers achieve their SWaP objectives. Using our high quality thin-film manufacturing process we can guarantee repeatability on large batches of filters.

FUNCTIONAL DIAGRAM



ELECTRICAL SPECIFICATIONS[1,2,3] AT +25°C

Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Units
Passband	Center Frequency[4]	—	—	—	8075	—	MHz
	Insertion Loss	F1-F2	7750 - 8400	—	1.6	2.7	dB
	Return Loss	F1-F2	7750 - 8400	—	14	—	dB
Stopband, Lower	Rejection	DC-F3	DC - 5500	40	56	—	dB
		F3-F4	5500 - 6300	20	41	—	
Stopband ,Upper	Rejection	F5-F6	9600 - 10500	20	42	—	dB
		F6-F7	10500 - 11500	—	40	—	

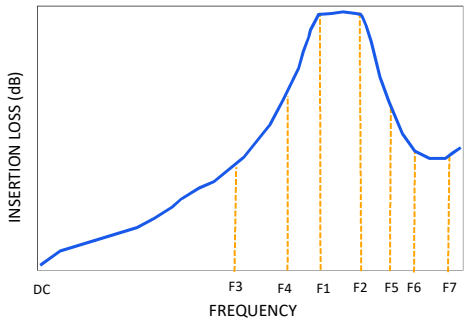
1. Tested on Evaluation Board P/N TB-ABF-8R075G+ with feedline losses removed by normalization of S12 and S21 traces to mesurement of TB thru-line.
2. This filter is bi-directional RF1 and RF2 ports may be interchanged, see S-Parameters for actual performance.
3. This component is not intended for use as a DC-blocking circuit element. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.
4. Typical variation ±3%.

ABSOLUTE MAXIMUM RATINGS[5]

Parameter	Ratings
Operating Temperature	-55 °C to +125 °C
Storage Temperature	-55 °C to +125 °C
Input Power[6]	1W Max. at 25°C

5. Permanent damage may occur if any of these limits are exceeded.
6. Power rating applies only to signals within the passband.

TYPICAL FREQUENCY RESPONSE AT +25°C



REV. B
ECO-024318
ABF-8R075G+
EDU4240
URJ
250127

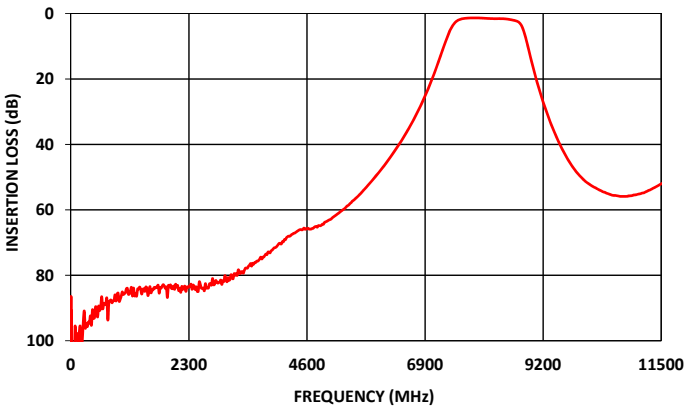
Bandpass Filter

ABF-8R075G+

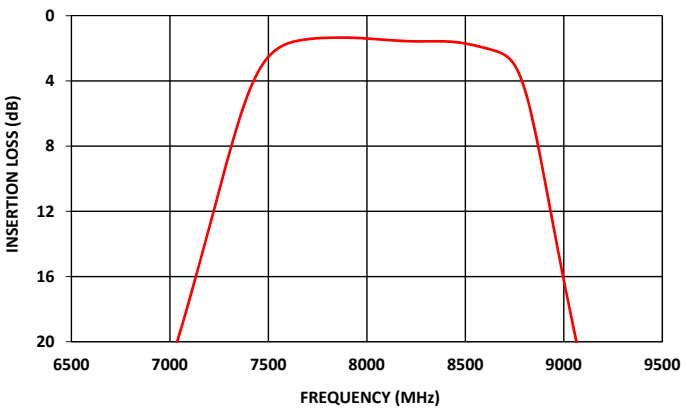
50Ω 7750 to 8400 MHz

TYPICAL PERFORMANCE GRAPHS AT +25°C

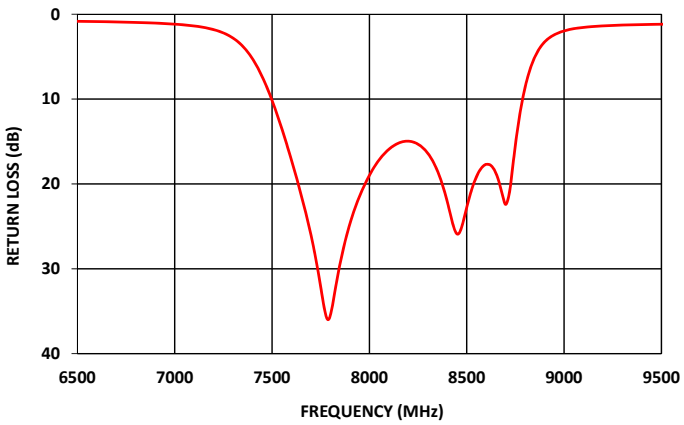
ABF-8R075G+
INSERTION LOSS



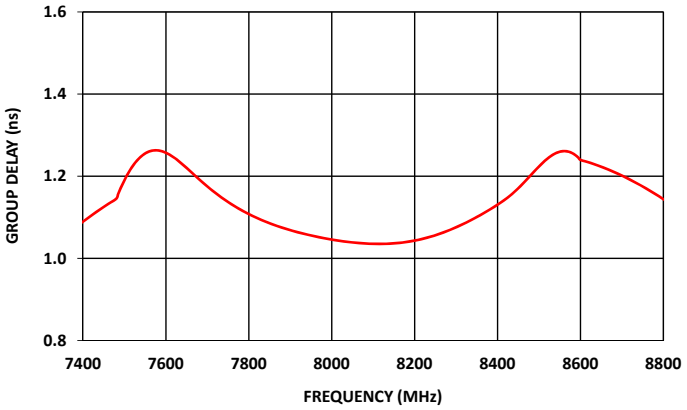
ABF-8R075G+
INSERTION LOSS (Zoomed)



ABF-8R075G+
RETURN LOSS



ABF-8R075G+
GROUP DELAY



THIN FILM SURFACE MOUNT

Bandpass Filter

ABF-8R075G+

50Ω 7750 to 8400 MHz

FUNCTIONAL DIAGRAM

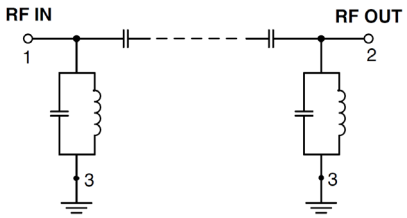
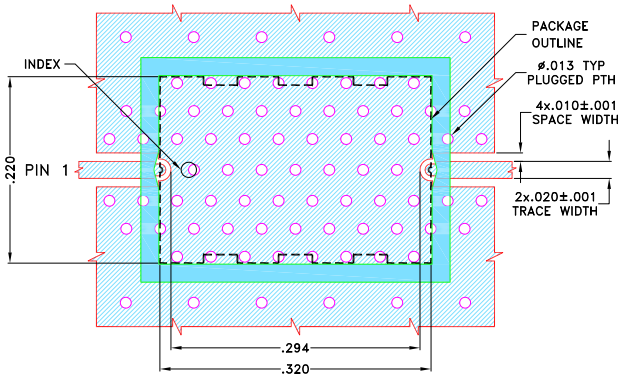


Figure 1. ABF-8R075G+ Functional Diagram

PAD DESCRIPTION

Function	Pad Number	Description
RF1[2]	1	Connects to RF Input Port
RF2[2]	2	Connects to RF Output Port
GROUND	3	Connects to Ground on PCB, (See drawing PL-652)
NC	—	No connection, not used internally. See drawing PL-652 for connection to PCB

SUGGESTED PCB LAYOUT (PL-652)

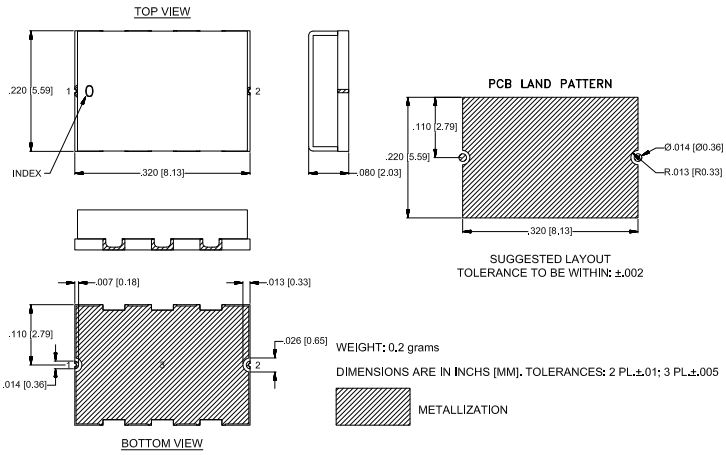


NOTES:
1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (RO4350B) WITH DIELECTRIC THICKNESS .010±.0010. COPPER: 1/2 Oz. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)
DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

Figure 2. Suggested PCB Layout PL-652

CASE STYLE DRAWING



PRODUCT MARKING*: ABF-8R075G

*Marking may contain other features or characters for internal lot control.

Bandpass Filter

ABF-8R075G+

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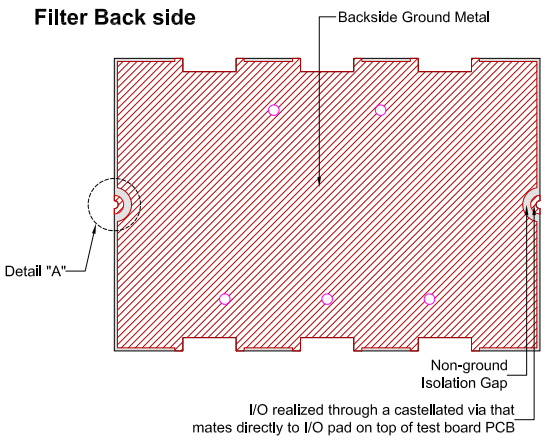
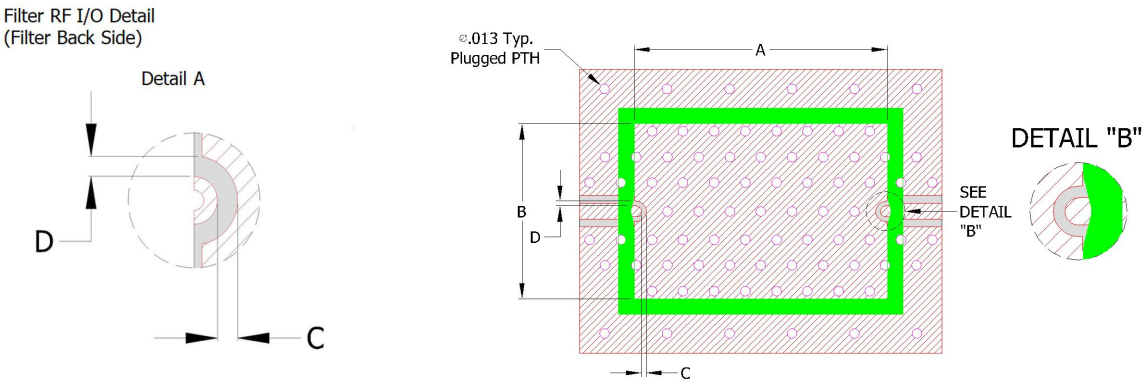
RECOMMENDED PCB LAYOUT PATTERN FOR FILTER



PCB Pattern Recommendations

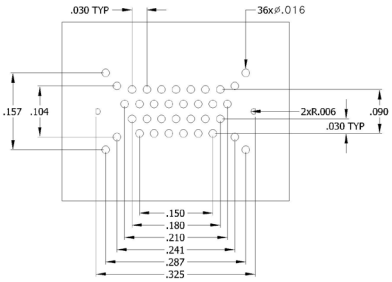


1) Customer PCB's ground pattern length (dimension A) can be similar to filter length.
2) Customer PCB's ground pattern width (dimension B) can be similar to filter width.
3) Dimensions C and D on Filter RF I/O detail and Customer PCB pattern can be closely match. The dimensions of C and D on the Customer PCB pattern can be slightly larger to account for component alignment tolerance (ground metal can be pulled back from RF I/O trace).
4) Recommend to use Solder mask at Customer PCB at outer area of filter pattern/ footprint with a clearance of about 1.25mil at each side. (Tighter registration tolerance required for solder mask)
5) Recommended to use Solder mask at I/O of Customer PCB as per above diagram (refer detail B).

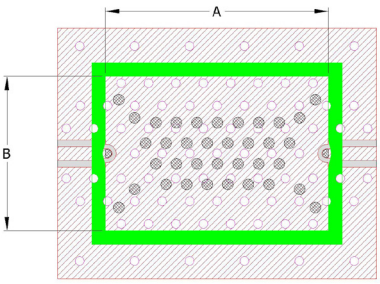
COMMENTS ON COMPONENT HANDLING AND SOLDER ATTACH

1) Avoid using soldering iron directly to the ceramic filter. This would lead to development of crack in the component due to thermal shock.
2) Vacuum pick-up tool or plastic tweezers are recommended for handling the components. Extra care should be taken not to scratch the filter or metal area.
3) Use 2-3 mil thickness stencil plate and screen print the solder. Refer below picture for recommended stencil pattern to get the best solder attachment.

Stencil opening drawing



Solder location after screen print



4) Plugged ground vias in the PWB will improve attachment consistency.
5) Recommended to have a similar or closer test board material and thickness (refer Mini-Circuits evaluation board for details) to minimize the CTE over the temperature range.

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ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASH BOARD. CLICK HERE

Performance Data and Graphs	Data Graphs S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads
Case Style	UC2731 Lead Finish: Gold over Nickel Plate
RoHS Status	Compliant
Tape and Reel	TR-F003
Suggested Layout for PCB Design	PL-652
Evaluation Board	TB-ABF-8R075G+
	Gerber File
Environmental Rating	ENV120

NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

Thin-Film Bandpass Filter ABF-8R075G+

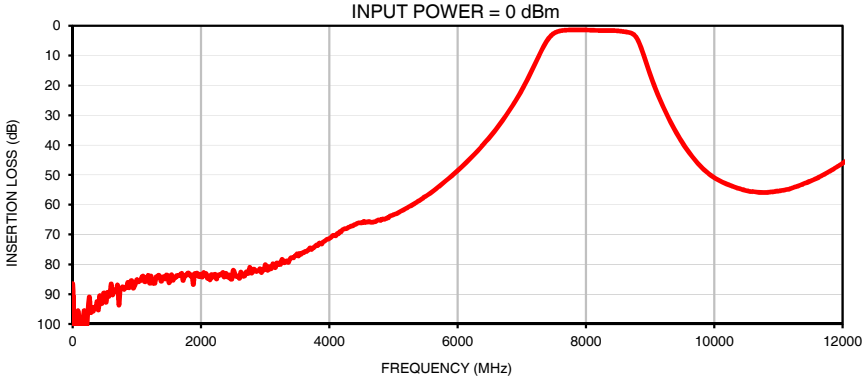
Typical Performance Data

FREQ.	Insertion Loss	Input Return Loss	Output Return Loss
(MHz)	(dB)	(dB)	(dB)
10	93.95	0.00	0.00
100	98.87	0.00	0.00
200	100.79	0.00	0.00
300	94.66	0.00	0.00
500	89.94	0.03	0.03
700	87.04	0.07	0.07
1000	85.09	0.14	0.14
1200	86.34	0.20	0.19
1400	84.39	0.26	0.25
1600	84.47	0.32	0.30
1800	82.87	0.37	0.35
2000	83.28	0.41	0.39
2500	82.04	0.48	0.46
3000	80.11	0.49	0.48
3500	76.43	0.47	0.46
4000	71.37	0.45	0.44
4500	66.13	0.48	0.48
5000	63.37	0.54	0.55
5500	57.15	0.63	0.63
6000	48.53	0.72	0.71
6300	42.19	0.78	0.78
6700	31.75	0.91	0.91
7000	21.48	1.17	1.16
7260	10.27	2.31	2.27
7460	3.19	7.89	7.87
7750	1.38	32.17	33.30
7800	1.35	35.44	39.19
7850	1.34	29.32	30.50
7900	1.34	24.68	25.24
8000	1.39	18.99	19.20
8075	1.46	16.47	16.57
8150	1.52	15.18	15.22
8200	1.56	14.96	14.99
8250	1.57	15.31	15.36
8300	1.57	16.39	16.50
8400	1.58	22.10	23.43
8760	3.24	13.67	13.49
8900	9.88	3.27	3.30
9100	21.99	1.55	1.55
9280	30.70	1.29	1.28
9600	42.31	1.15	1.13
9640	43.44	1.14	1.12
9680	44.54	1.13	1.11
9720	45.56	1.13	1.11
9760	46.51	1.12	1.10
9800	47.40	1.11	1.09
9840	48.27	1.11	1.09
9880	49.01	1.11	1.08
9920	49.70	1.10	1.07
9960	50.33	1.09	1.07
10000	50.96	1.08	1.07
10040	51.52	1.09	1.06
10080	51.96	1.08	1.05
10120	52.36	1.07	1.05
10160	52.77	1.07	1.05
10200	53.15	1.07	1.05
10500	55.27	1.05	1.02
10600	55.58	1.04	1.01
11000	55.40	1.02	1.01
11500	52.06	1.02	1.04

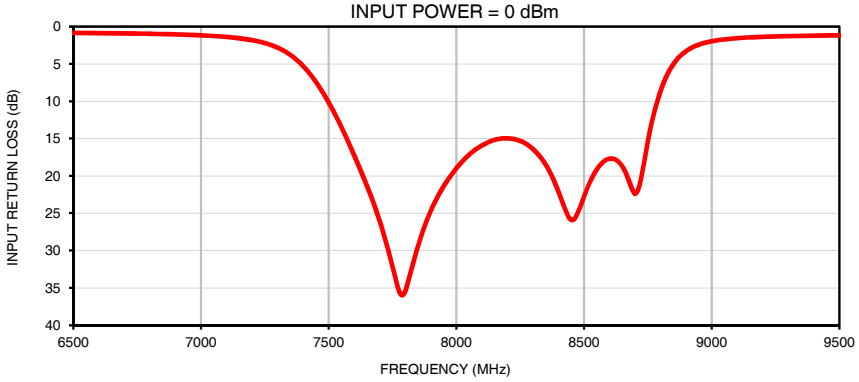
FREQ.	Group Delay
(MHz)	(ns)
7750	1.14
7760	1.13
7770	1.12
7780	1.12
7790	1.11
7800	1.11
7810	1.10
7820	1.10
7830	1.09
7840	1.09
7850	1.09
7860	1.08
7870	1.08
7880	1.07
7890	1.07
7900	1.07
7910	1.07
7920	1.06
7930	1.06
7940	1.06
7950	1.06
7960	1.05
7970	1.05
7980	1.05
7990	1.05
8000	1.05
8010	1.04
8020	1.04
8030	1.04
8040	1.04
8050	1.04
8060	1.04
8075	1.04
8090	1.04
8100	1.04
8110	1.04
8120	1.04
8130	1.04
8140	1.04
8150	1.04
8160	1.04
8170	1.04
8180	1.04
8190	1.04
8200	1.04
8210	1.05
8220	1.05
8230	1.05
8240	1.05
8250	1.06
8260	1.06
8270	1.06
8280	1.07
8290	1.07
8300	1.08
8310	1.08
8320	1.09
8330	1.09
8350	1.10
8400	1.13

Typical Performance Curves

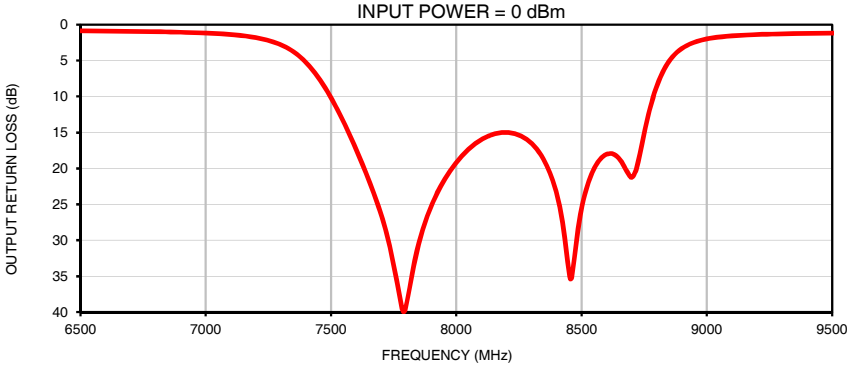
INSERTION LOSS
INPUT POWER = 0 dBm



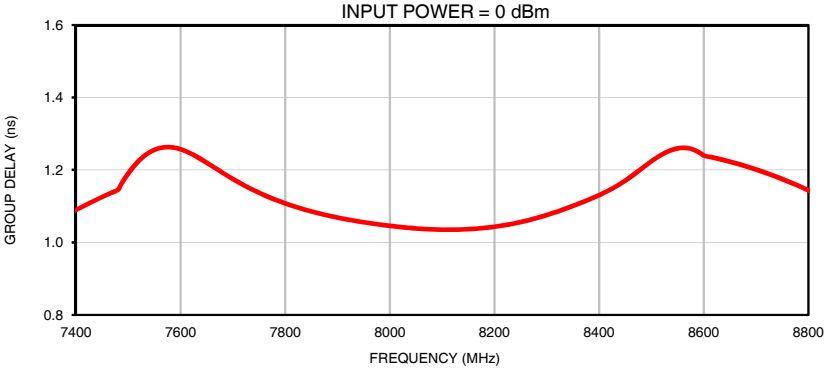
INPUT RETURN LOSS
INPUT POWER = 0 dBm



OUTPUT RETURN LOSS
INPUT POWER = 0 dBm

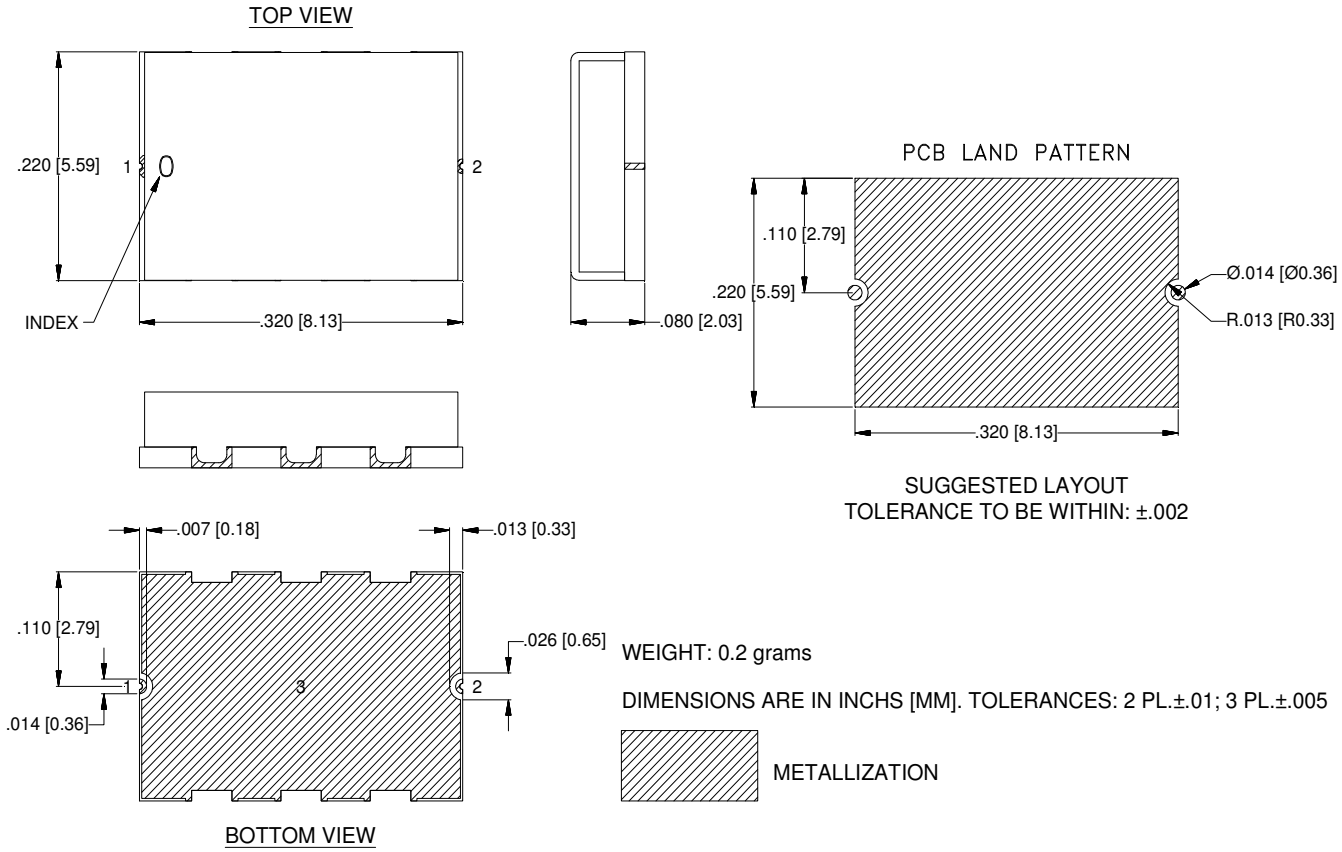


GROUP DELAY
INPUT POWER = 0 dBm



Case Style UC

Outline Dimensions UC2731



Notes:

1. Case material: Gold over Nickel over Annealed Stainless Steel.
2. Base: Ceramic
3. Termination finish: **as shown below or indicated on Data Sheet.**
   For RoHS Case Styles: Gold over Nickel plate. All models, (+) suffix.

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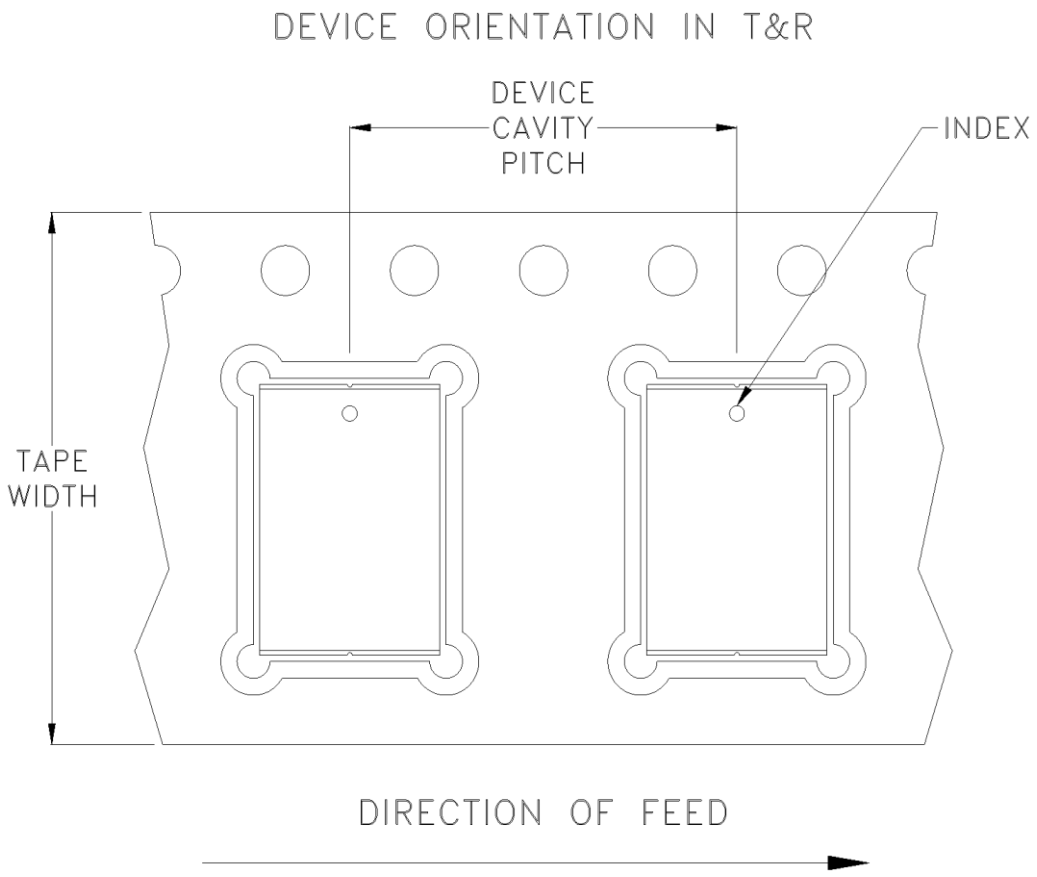
Tape & Reel Packaging TR-F003



Tape Width, mm	Device Cavity Pitch, mm	Real Size, inches	Devices per Reel See note
16	12	7	10
			20
			50
			100
			200
		13	500

Note: Please consult individual model data sheet/dashboard to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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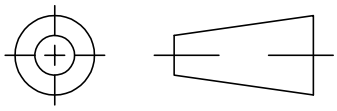
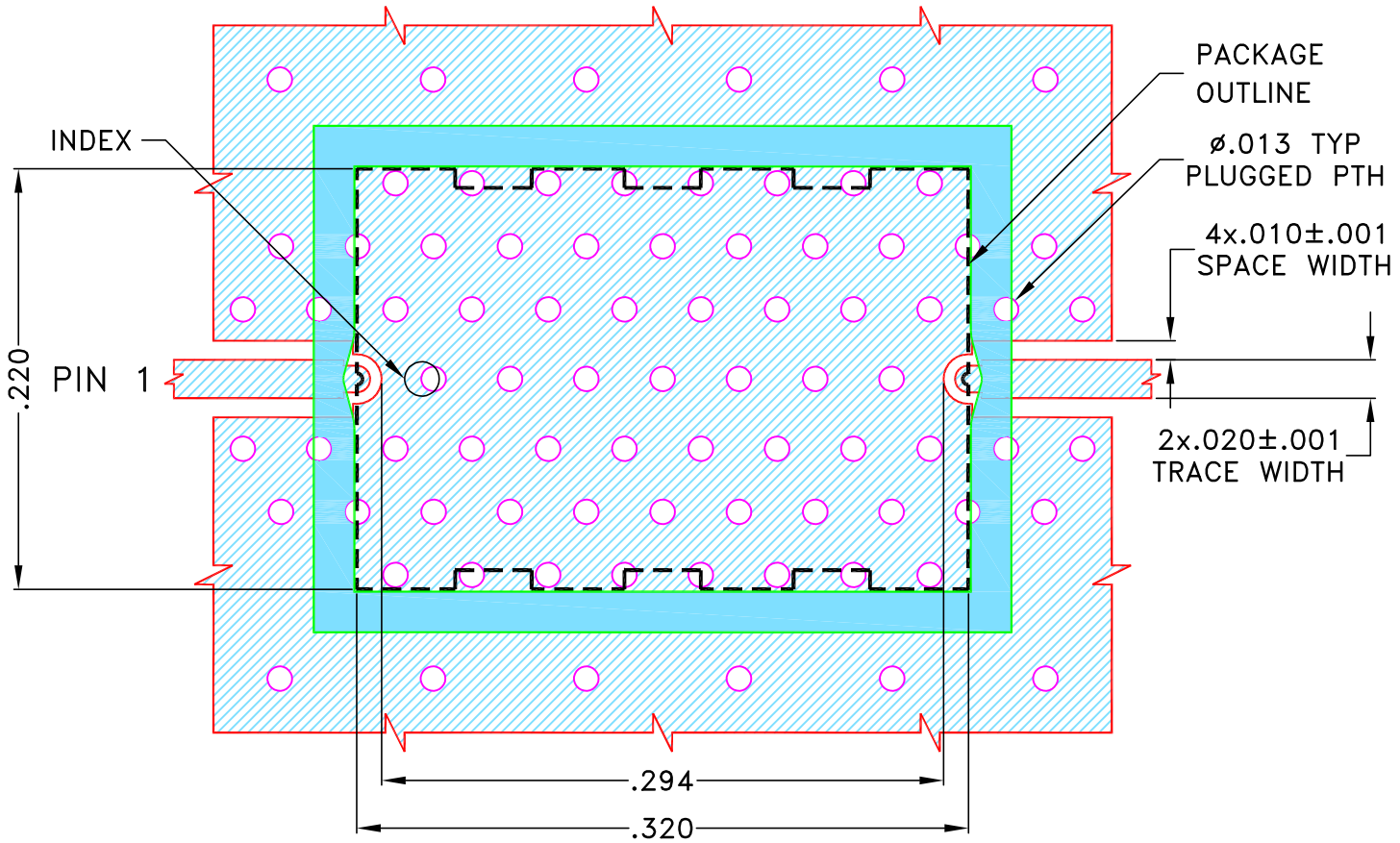
THIRD ANGLE PROJECTION



REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	ECO-007104	NEW RELEASE	MAR 21	DDR	VC
A	ECO-010633	UPDATED AS PER CURRENT TEST BOARD	NOV 21	DDR	VC
B	ECO-019739	UPDATED TRACE AND SPACE WIDTH	OCT 23	LK	VC
		TOLERANCE ONLY NO OTHER CHANGES			

SUGGESTED MOUNTING CONFIGURATION FOR UC2731 CASE STYLE



NOTES:

1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (RO4350B) WITH DIELECTRIC THICKNESS .010±.0010. COPPER: 1/2 Oz. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	DDR	29 MAR 21
TOLERANCES ON:	CHECKED	RR	29 MAR 21
2 PL DECIMALS ± .005	APPROVED	NN	29 MAR 21
3 PL DECIMALS ±			
ANGLES ±			
FRACTIONS ±			

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ASHEETA1.DWG REV:A DATE:01/12/95

Mini-Circuits®
13 Neptune Avenue
Brooklyn NY 11235

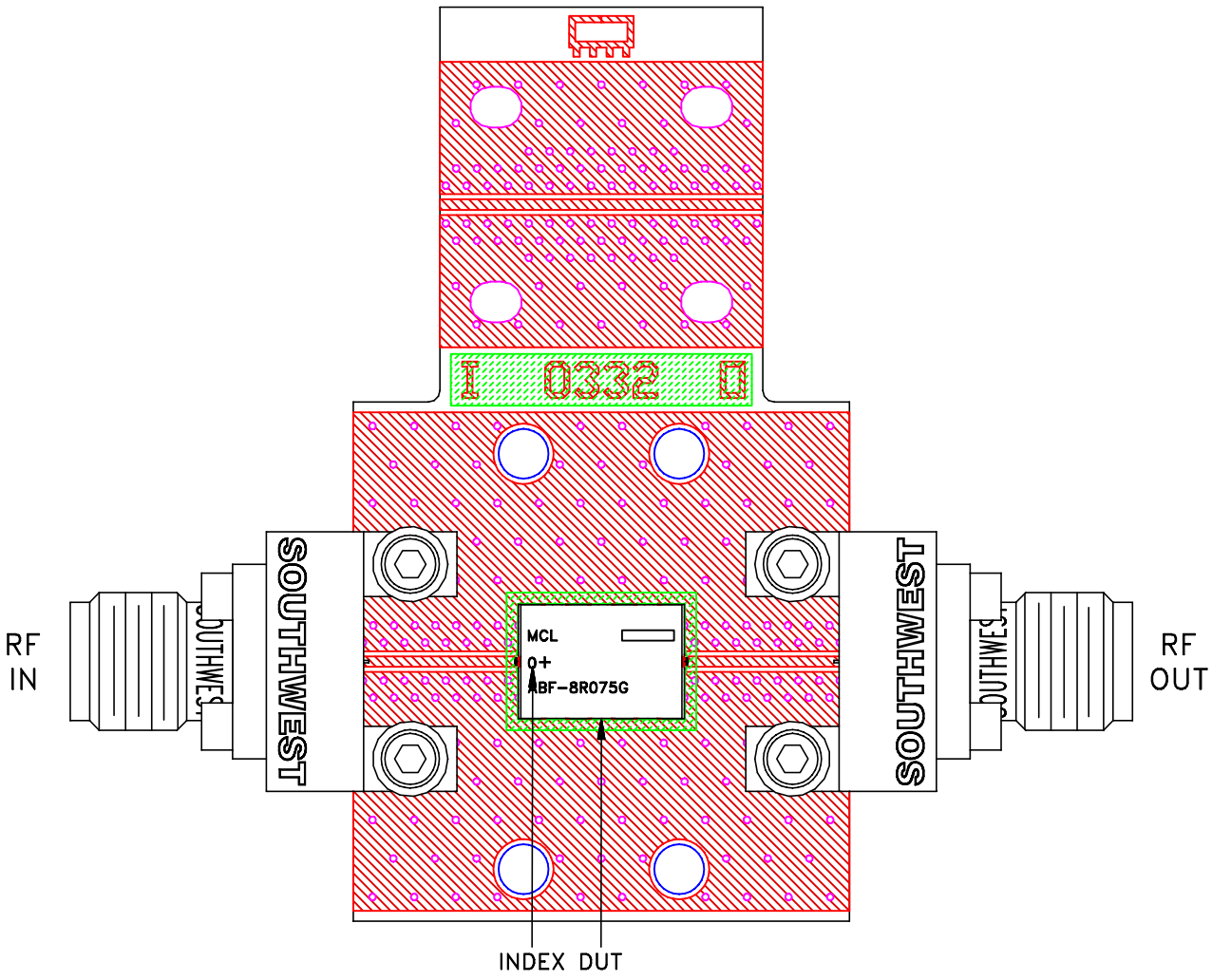
PL DWG, UC2731 C.S, 50 OHM, ABF

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-652	B

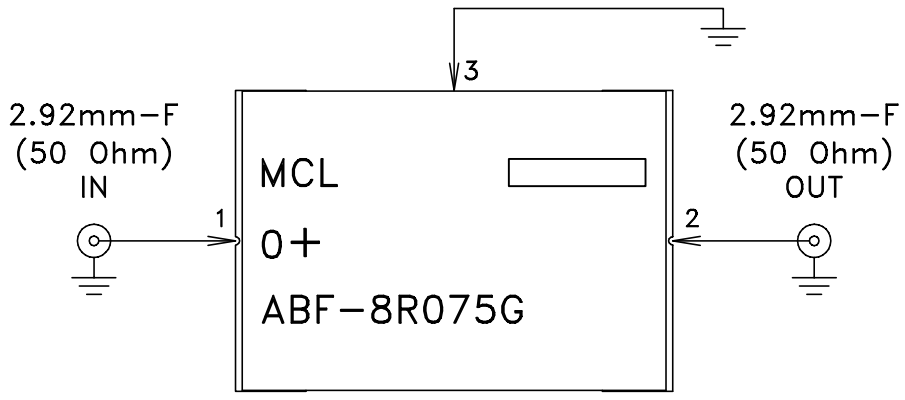
FILE:	SCALE:	SHEET:
98-PL-652	10:1	1 OF 1

Evaluation Board and Circuit

TB-ABF-8R075G+



Schematic diagram



Notes:

1. PCB Material: ROGERS (RO4350B) OR Equivalent, Dielectric Constant=3.48±.05
Dielectric Thickness: .010±.001
2. 50 Ohm 2.92mm Female Connectors.

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Mini-Circuits

Environmental Specifications ENV120

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Thermal Shock	-55° to 125°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, Except +125°C

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